## mail

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

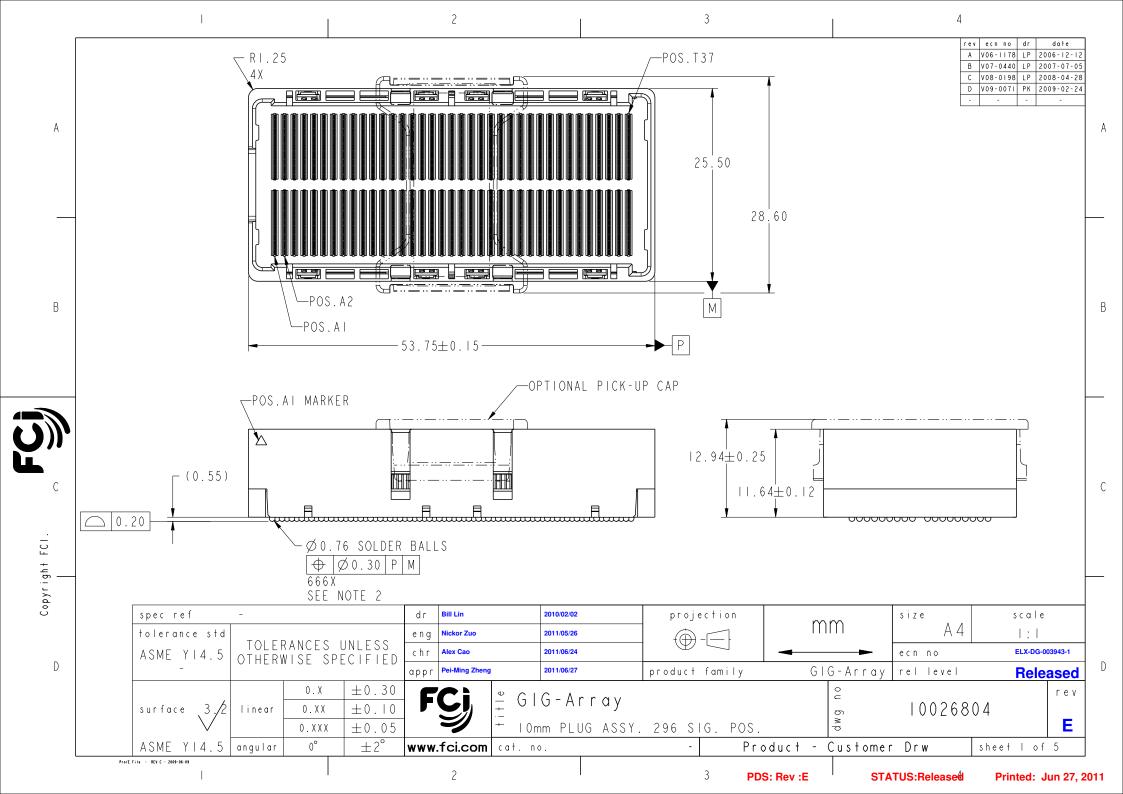
We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

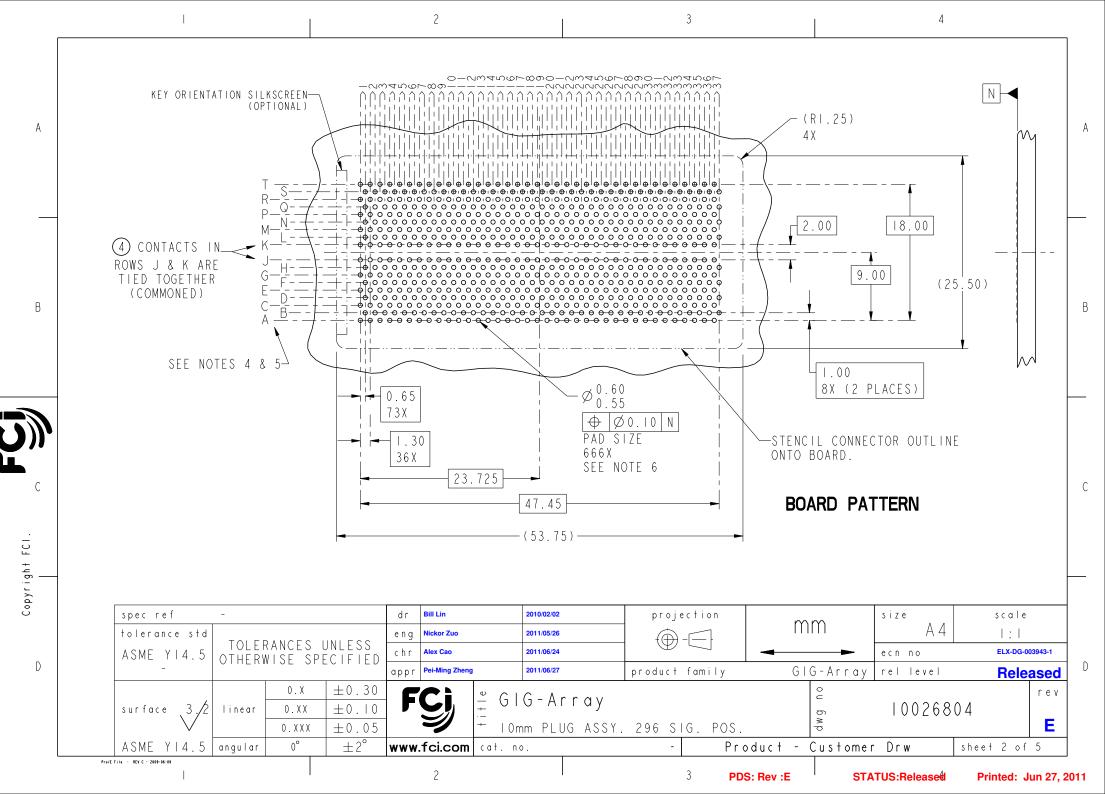


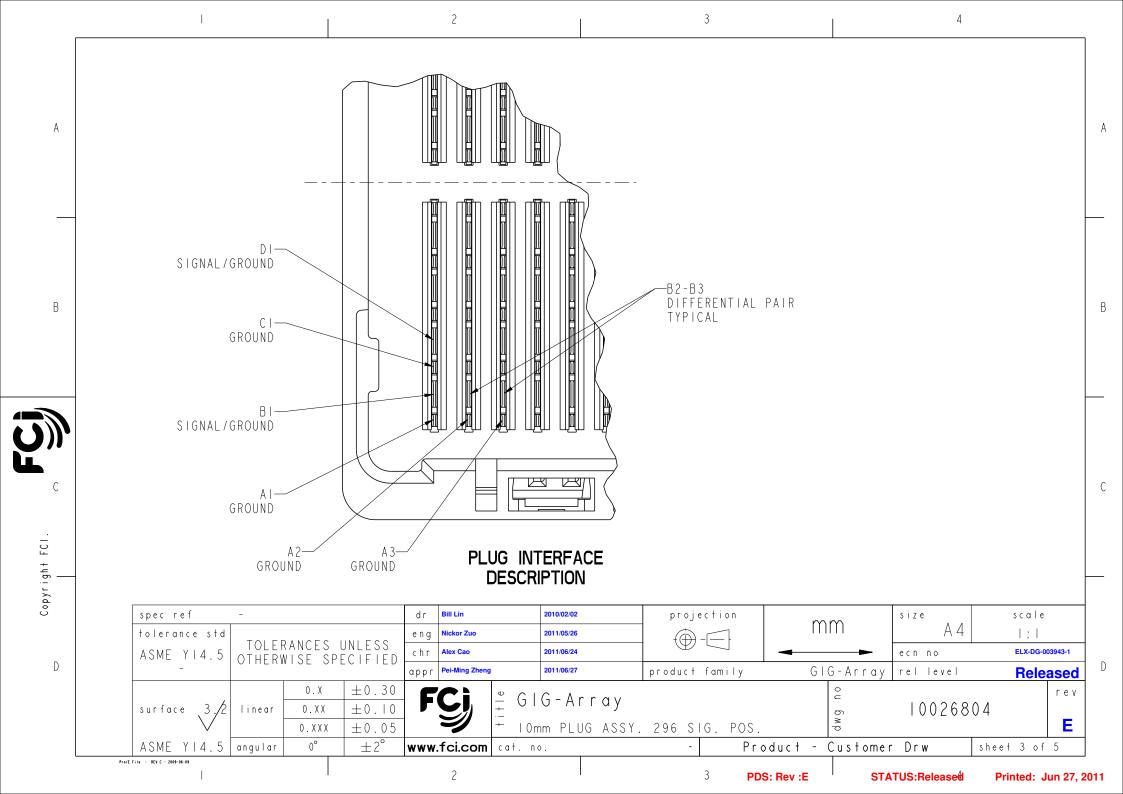
## Contact us

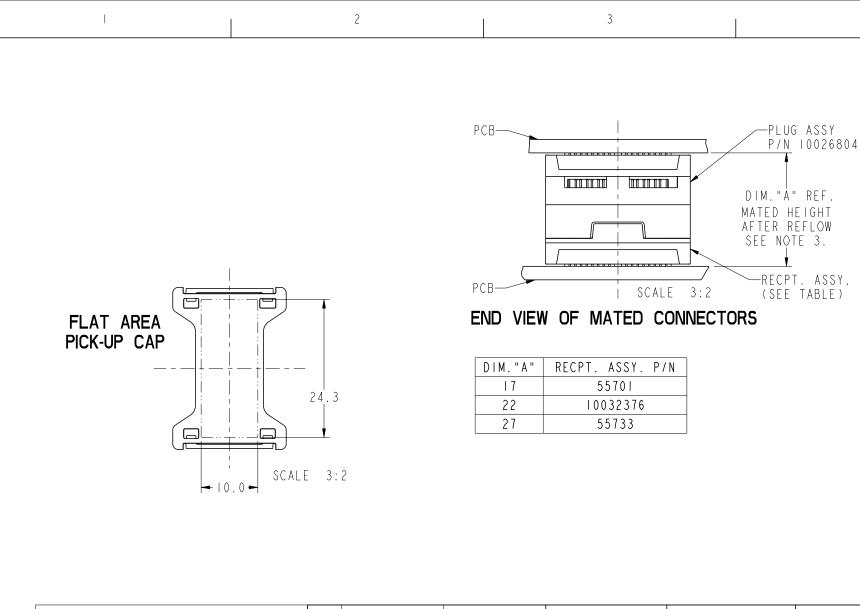
Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China











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	spec ref	-			dr	Bill Lin		2010/02/02		project	ion	$\sim$	$\sim$	size	S	cale	
	tolerance std				eng	eng Nickor Zuo		2011/05/26		÷	-1	mm		A 4		1:1	
	ASME YI4.5	SME YI4.5 TOLERANCES UNLESS OTHERWISE SPECIFIED		chr Alex Cao			2011/06/24				◄ ►		ecn no		ELX-DG-003943-1		
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Pro/E	File - REV C - 2009-06-09					2				3	PDS	: Rev :E	STA	TUS:Released	Printe	ed: Ju	n 27, 2011

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	PRODUCT NUMBER 10026804-001 10026804-001LF	SOLDER BALL COMPOSITION STANDARD (EUTECTIC) LEADFREE	CONTACT PLATING PERFORMANCE LEVEL PERFORMANCE-BASED PLATING, QUALIFIED TO MEET THE REQUIREMENTS OF FCI PRODUCT SPECIFICATION GS-12-192, INCLUDING TELCORDIA CENTRAL OFFICE	
А				A
	NOTES:	′L: DUSING: LCP	NOTES CONTINUED	
В	CC PI UI (2) SOLD SHPET (3) MATE PCB PROF (4) CONT ARE S	DNTACT: COPPER ALLOY LATING (CONTACT): AU OVER NI. L RATING: 94 V-O DER BALLS WILL NOT BE PERFECT RICAL SHAPE DUE TO REFLOW ATTACH ED HEIGHT EFFECTED BY CUSTOMERS ' PAD SIZE, PLATING, SOLDER REFLOW ILE & SOLDER PASTE. 'ACTS IN ROWS A,C,E,G,J,K,M,P,R AN SINGLE BEAM CONTACTS,	<ul> <li>(6) SPECIFIED POSITIONAL TOLERANCE DEFINES PAD TO PAD LOCATION WITHIN LAND PATTERN. POSITIONAL TOLERANCE OF LAND PATTERN TO FUDICIAL MARKS OR PCB DATUMS SHALL BE DEFINED BY CUSTOMER. FOR RECOMMENDED PRODUCT APPLICATION AND PCB DESIGN DETAILS, SEE DOC. NO. GS-20-016.</li> <li>(7) FOR PROPER APPLICATION FOLLOW FCI APPLICATION SPECIFICATION GS-20-033 LEADFREE SOLDER BALLS W WILL NOT SOLDER PROPERLY IN A LEADED SOLDER PROCESS DUE TO A HIGHER REFLOW TEMPERATURE, LEADFREE PRODUCT IS THERFORE NOT BACKWARDS COMPATIBLE WITH LEADED OR SOME SOLDERING APPLICATIONS. REFERENCE FCI APPLICATION SPECIFICATION.</li> </ul>	B
ight FCI.	(NOTI 5) cont Are i	CALLY USED AS GROUND PINS. E: CONTACTS IN ROWS J & K ARE TIED TOGETHER [COMMONED]) FACTS IN ROWS B,D,F,H,L,N,Q AND DUAL BEAM CONTACTS, CALLY USED AS SIGNAL PINS.	(8) THIS PRODUCT MEETS THE EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008. PRODUCT MEETING WITH THES DIRECTIVE IS IDENTIFIED IN THE LOT CODE NUMBER MARKED ON EACH PART BY HAVING AN "X" IN THE SEVENTH CHARACTER POSITION.	C
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spec ref	-			dr	Bill Lin	2010/02/02		projecti	on	~~~	00	size	sca	e	
tolerance std				eng	Nickor Zuo	2011/05/26		⊕-∈		m		A 4	1:	I	
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